MN101CF95F, MN101CF95G

| Туре | MN101CF95F | MN101CF95G |
|---------------------------------------|--|-------------------------------------|
| Internal ROM type | FLASH | |
| ROM (byte) | 96K | 128K |
| RAM (byte) | 4K | 6K |
| Package (Lead-free) | TQFP080-P-1212D (Under planning) | TQFP080-P-1212D (Under development) |
| Minimum Instruction Execution Time | [Standard] 0.2 μs (at 2.7 V to 3.6 V, 10 MHz) 0.5 μs (at 2.7 V to 3.6 V, 4 MHz) 62.5 μs (at 2.7 V to 3.6 V, 32 kHz) [Double speed] | |
| heet4U.com | 0.1 µs (at 2.7 V to 3.6 V, 10 MHz) | |

■ Interrupts

RESET, Watchdog, External 0 to 5, Timer 0 to 8, Time base, Serial 0 reception, Serial 0 transmission, Serial 1 reception, Serial 1 transmission, Serial 2, Serial 3, Serial 4 reception, Serial 4 transmission, Automatic transfer finish, A/D conversion finish, Key interrupts (12 lines)

■ Timer Counter

Timer counter 0 : 8-bit \times 1

(square-wave/8-bit PWM output, event count, pulse width measurement, serial clock output, real-time output control, generation of remote control carrier)

Interrupt source coincidence with compare register 0

Timer counter 1:8-bit × 1 (square-wave output, event count, synchronous output event, serial clock output)

XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 1

Timer counter 0, 1 can be cascade-connected.

Timer counter 2 : 8-bit \times 1

(square-wave output, PWM output, event count, pulse width measurement, synchronous timer, serial clock output)

 $Clock\ source......1/2,\ 1/4\ of\ system\ clock\ frequency;\ 1/1,\ 1/4,\ 1/16,\ 1/32,\ 1/64\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1\ of\ system\ clock\ frequency;\ 1/2\ of\ system\ clock\ frequency;\ 1/$

XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 2

Timer counter 0, 1, 2 can be cascade-connected.

Timer counter 3:8-bit × 1 (square-wave output, event count, serial clock output)

XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 3

Timer counter 2, 3 can be cascade-connected.

Timer counter 0, 1, 2, 3 can be cascade-connected.

Timer counter 4 : 8-bit \times 1

(square-wave/8-bit PWM output, event count, pulse width measurement, real-time output control, serial clock output)

XI oscillation clock frequency; 1/1 of external clock input frequency

Interrupt source coincidence with compare register 4

Timer counter 5 : 8-bit \times 1

(square-wave/8-bit PWM output, event count, pulse width measurement, serial clock output)

XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 5

Timer counter 4, 5 can be cascade-connected.

Timer counter 6: 8-bit freerun timer

of XI oscillation clock frequency

Interrupt source coincidence with compare register 6

Timer counter 7: 16-bit × 1

(square-wave/16-bit PWM output, cycle / duty continuous variable, event count, synchronous output evevt, pulse width measurement, input capture, real-time output control)

1/2, 1/4, 1/16 of external clock input frequency

Interrupt source coincidence with compare register 7 (2 lines)

Timer counter 8 : 16-bit \times 1

www.DataSheet4U.co(square-wave output, PWM output (duty continuous variable), event count, pulse width measurement, input capture)

 $Clock\ source.....1/1,\ 1/2,\ 1/4,\ 1/16\ of\ system\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1/2,\ 1/4,\ 1/16\ of\ OSC\ oscillation\ clock\ frequency;\ 1/1,\ 1/2,\ 1$

1/2, 1/4, 1/16 of external clock input frequency

Interrupt source coincidence with compare register 8 (2 lines)

Time base timer (one-minute count setting)

Interrupt source 1/128, 1/256, 1/512, 1/1024, 1/8192, 1/32768 of clock source frequency

Watchdog timer

Interrupt source 1/65536, 1/262144, 1/1048576 of system clock frequency

■ Serial interface

Serial 0 : synchronous type / UART (full-duplex) × 1

Serial 1: synchronous type / UART (full-duplex) × 1

Serial 2 : synchronous type / multi-master $I^2C \times 1$

Serial 3: synchronous type / single-master I²C × 1

Serial 4 : synchronous type / UART (full-duplex) × 1

■ DMA controller

Max. Transfer cycles: 255

Starting factor: various types of interrupt, software

Transfer mode: 1-byte transfer, word transfer, burst transfer

■ I/O Pins

| I/O | 67 | Common use , Specified pull-up resistor available, Input/output selectable (bit unit) |
|-----|----|---|
|-----|----|---|

■ A/D converter

10-bit × 11-ch. (with S/H)

■ Special Ports

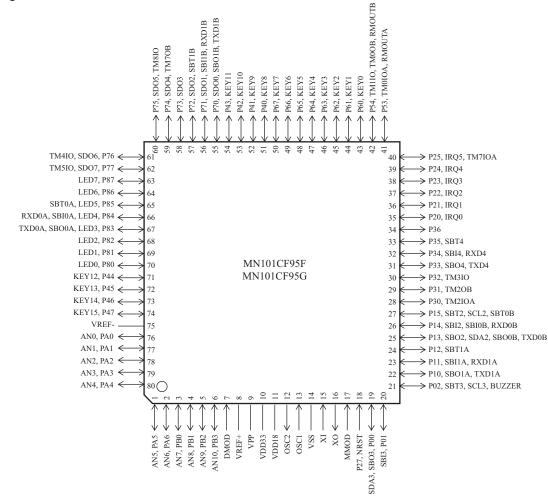
Buzzer output, remote control carrier signal output, high-current drive port

Development tools

In-circuit Emulator

PX-ICE101C/D+PX-PRB101C95-TQFP080-P-1212D

■ Pin Assignment



TQFP080-P-1212D

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